



Empowering Advanced Applications

At the LEX COMPUTECH booth, visitors will explore a comprehensive range of embedded platforms powered by Intel® processors—from the LEX SYSTEM 2I740DW featuring the latest energy-efficient Intel Atom® platform, to the high-performance LEX SYSTEM CI870CW, 3I140DW, and 3I140HW equipped with Intel® Core™ Ultra processor. With flexible configurations, each platform can be deployed in ultra-compact fanless enclosures or ruggedized chassis, delivering proven stability for mission-critical and harsh environments. Committed to customization and reliability, LEX SYSTEM solutions empower advanced applications across factory automation, intelligent transportation, edge AI, and defense communications.

Partner Link:

https://www.lex.com.tw/en/products/embedded-ipc-board/board-page/2/530-rock-2i130dw

Meeting Request Link:

https://www.lex.com.tw/en/contact/inquiry-list

Partner Name

LEX COMPUTECH CO., LTD.

Booth Location 5051

Solution Names

- **2I740DW:** 2.5" Plus motherboard
- 31140DW: 3.5" motherboard
- NET-III 21640HL: Embedded System
- ROCK 21130DW: Embedded System

